

ELECTRICAL SPECIFICATIONS								
PARAMETER	SYMBOL	TEST CO	VALUES	UNITS				
Maximum forward voltage drop	V_{FM}	20 A, T _J = 25 °C	1.31	V				
Forward slope resistance	r _t	T _{.1} = 150 °C	11.88	mΩ				
Threshold voltage	V _{F(TO)}	1J = 150 C	0.93	V				
Maximum reverse leakage current	I _{RM}	T _J = 25 °C	V Potod V	0.1	mA			
Maximum reverse leakage current		T _J = 150 °C	V _R = Rated V _{RRM}	6				

RECOVERY CHARACTERISTICS									
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	· •				
Reverse recovery time	t _{rr}	In at 20 And	400	ns	I _{FM} +				
Reverse recovery current	I _{rr}	I _F at 20 A _{pk} 25 A/μs	6.1	Α	$t_a \mid t_b$				
Reverse recovery charge	Q_{rr}	25 °C	1.7	μC	dir/ Q.,				
Snap factor	S	Typical	0.6		I _{RM(REC)}				

THERMAL - MECHANICAL SPECIFICATIONS								
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS				
Maximum junction and storage temperature range	T _J , T _{Stg}		-40 to +150	°C				
Maximum thermal resistance, junction to case	R _{thJC}	DC operation		°C/W				
Maximum thermal resistance, junction to ambient (PCB mount)	' I Bull 14 \'/ I		62					
Soldering temperature	T _S		260	°C				
Approximate weight			2	g				
Approximate weight			0.07	OZ.				
			20ETF08S					
Marking device		Case style TO-263AB (D ² PAK)	20ETF10S					
			20ETF12S					

Note

⁽¹⁾ When mounted on 1" square (650 mm²) PCB of FR-4 or G-10 material 4 oz. (140 µm) copper 40 °C/W For recommended footprint and soldering techniques refer to application note #AN-994

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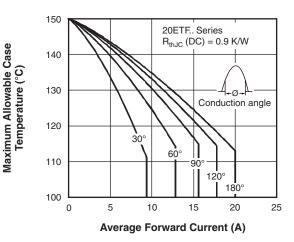


Fig. 1 - Current Rating Characteristics

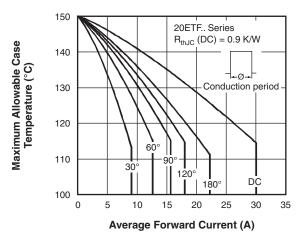


Fig. 2 - Current Rating Characteristics

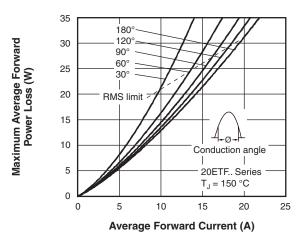


Fig. 3 - Forward Power Loss Characteristics

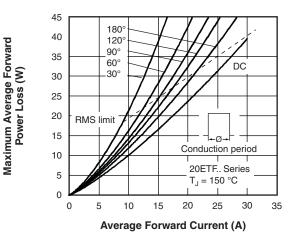


Fig. 4 - Forward Power Loss Characteristics

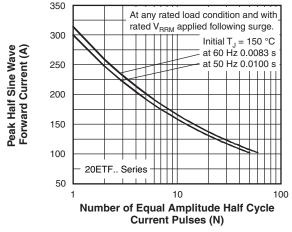


Fig. 5 - Maximum Non-Repetitive Surge Current

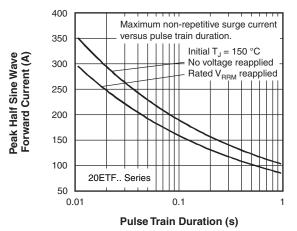


Fig. 6 - Maximum Non-Repetitive Surge Current

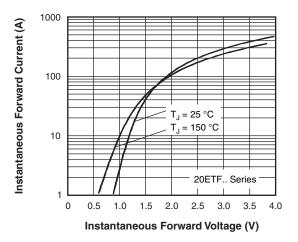


Fig. 7 - Forward Voltage Drop Characteristics

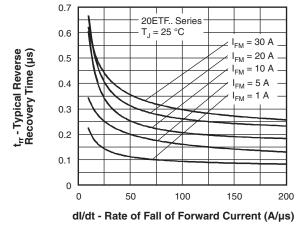


Fig. 8 - Recovery Time Characteristics, $T_J = 25$ °C

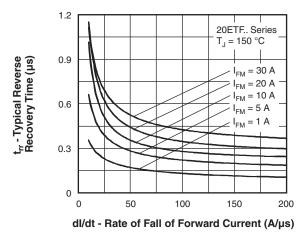


Fig. 9 - Recovery Time Characteristics, $T_J = 150 \, ^{\circ}\text{C}$

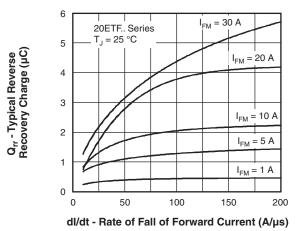
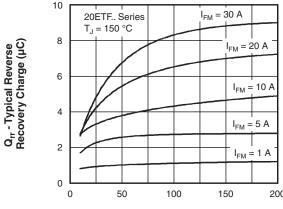


Fig. 10 - Recovery Charge Characteristics, $T_J = 25$ °C



dl/dt - Rate of Fall of Forward Current (A/µs)

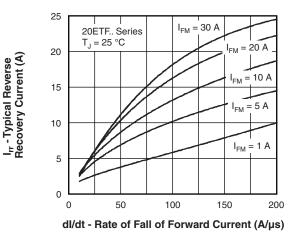
Fig. 11 - Recovery Charge Characteristics, $T_J = 150 \, ^{\circ}\text{C}$





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35 20ETF.. Series $I_{FM} = 30 A$ $T_J = 150 \, ^{\circ}C$ 30 I_{rr} - Typical Reverse Recovery Current (A) = 20 A 25 I_{FM} = 10 A 20 = 5 A 15 10 $I_{FM} = 1 A$ 5 0 50 100 150 0 200 dl/dt - Rate of Fall of Forward Current (A/µs)

Fig. 12 - Recovery Current Characteristics, T_J = 25 °C

Fig. 13 - Recovery Current Characteristics, T_J = 150 °C

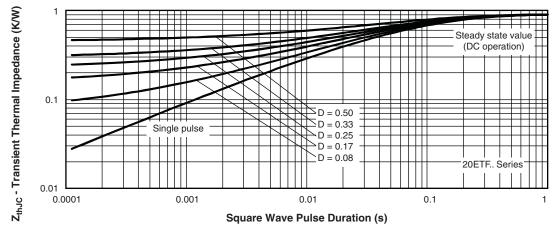
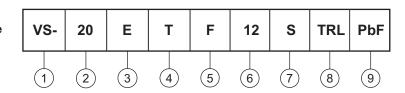


Fig. 14 - Thermal Impedance Z_{thJC} Characteristics

ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

2 - Current rating (20 = 20 A)

Circuit configuration:

E = single diode

4 - Package:

 $T = TO-263AB (D^2PAK)$

5 - Type of silicon:

F = fast soft recovery rectifier

08 = 800 V

- Voltage code x 100 = V_{RRM}

10 = 1000 V 12 = 1200 V

7 - S = surface mountable

8 - • None = tape

• TRR = tape and reel (right oriented)

• TRL = tape and reel (left oriented)

9 - None = standard production

• PbF = lead (Pb)-free

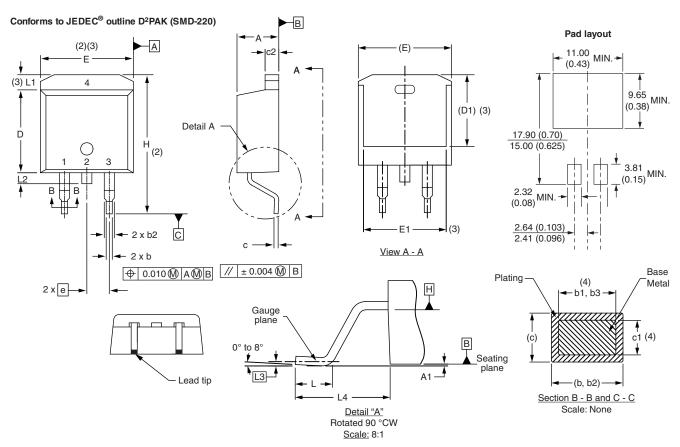
ORDERING INFORMATION (Example)								
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION					
VS-20ETF08SPbF	50	1000	Antistatic plastic tubes					
VS-20ETF08STRRPbF	800	800	13" diameter reel					
VS-20ETF08STRLPbF	800	800	13" diameter reel					
VS-20ETF10SPbF	50	1000	Antistatic plastic tubes					
VS-20ETF10STRRPbF	800	800	13" diameter reel					
VS-20ETF10STRLPbF	800	800	13" diameter reel					
VS-20ETF12SPbF	50	1000	Antistatic plastic tubes					
VS-20ETF12STRRPbF	800	800	13" diameter reel					
VS-20ETF12STRLPbF	800	800	13" diameter reel					

LINKS TO RELATED DOCUMENTS						
Dimensions	www.vishay.com/doc?95046					
Part marking information	www.vishay.com/doc?95054					
Packaging information	www.vishay.com/doc?95032					



D²PAK

DIMENSIONS in millimeters and inches



SYMBOL -	MILLIMETERS		INCHES		NOTES	SYMBOL	MILLIMETERS		INCHES		NOTES	
	MIN.	MAX.	MIN.	MAX.	NOTES		STINIBUL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.06	4.83	0.160	0.190			D1	6.86	8.00	0.270	0.315	3
A1	0.00	0.254	0.000	0.010			Е	9.65	10.67	0.380	0.420	2, 3
b	0.51	0.99	0.020	0.039			E1	7.90	8.80	0.311	0.346	3
b1	0.51	0.89	0.020	0.035	4		е	2.54 BSC		0.100 BSC		
b2	1.14	1.78	0.045	0.070			Н	14.61	15.88	0.575	0.625	
b3	1.14	1.73	0.045	0.068	4		L	1.78	2.79	0.070	0.110	
С	0.38	0.74	0.015	0.029			L1	-	1.65	-	0.066	3
c1	0.38	0.58	0.015	0.023	4		L2	1.27	1.78	0.050	0.070	
c2	1.14	1.65	0.045	0.065			L3	0.25 BSC		0.010 BSC		
D	8.51	9.65	0.335	0.380	2		L4	4.78	5.28	0.188	0.208	

Notes

- (1) Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inch
- (7) Outline conforms to JEDEC® outline TO-263AB

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